S1C33T01



32-bit Single Chip Microcontroller

- High-speed 32-bit RISC Core
- Multiply Accumulation
- 8K-byte RAM Built-in
- 10-bit ADC
- 4-ch. SIO. 2-ch. I²C
- High-speed DMA, Intelligent DMA

■ DESCRIPTIONS

The S1C33T01 is a CMOS 32-bit microcomputer composed of a CMOS 32-bit RISC core, 8K-byte RAM, DMA, 4-ch. SIO, 2-ch. I2C, ADC, timers, PLL and oscillators. The S1C33T01 features high-speed operation and low current consumption. The S1C33T01 also provides a DSP function using the internal MAC (multiplication and accumulation) operation function with the A/D converter, this makes it possible to achieve speech recognition and voice synthesis systems.

■ FEATURES

CMOS LSI 32-bit parallel processing S1C33000 RISC core

Main clock 60MHz (Max., up to 15MHz external clock input)

Sub clock 32.768kHz (Typ., crystal)

Instruction set 16-bit fixed length, 105 instructions

(MAC instruction is included, 2 cycles)

Internal RAM size 8.192 bytes Clock timer 1 channel

Programmable timer 8 bits × 6 channels and 16 bits × 10 channels PWM timer Realized with a 16-bit programmable timer Realized with a 16-bit programmable timer Watchdog timer

Serial interface 4 channels

Clock synchronization type and asynchronization type are selectable.

Usable as an infrared ray (IrDA) interface. Single master type, 2 channels (option)

●I²C bus

Successive approximation type, 8 input channels 10-bit A/D converter

High-speed DMA 4 channels Intelligent DMA 128 channels ●I/O port Input port: 13 bits

I/O port: 69 bits

External interrupts: 18 types Interrupt controller Internal interrupts: 69 types

24-bit address bus, 16-bit data bus, 7 chip enable pins External bus interface

DRAM and burst ROM may be connected directly.

QFP21-176pin Shipping form

Core voltage: 1.8 to 3.6V Supply voltage

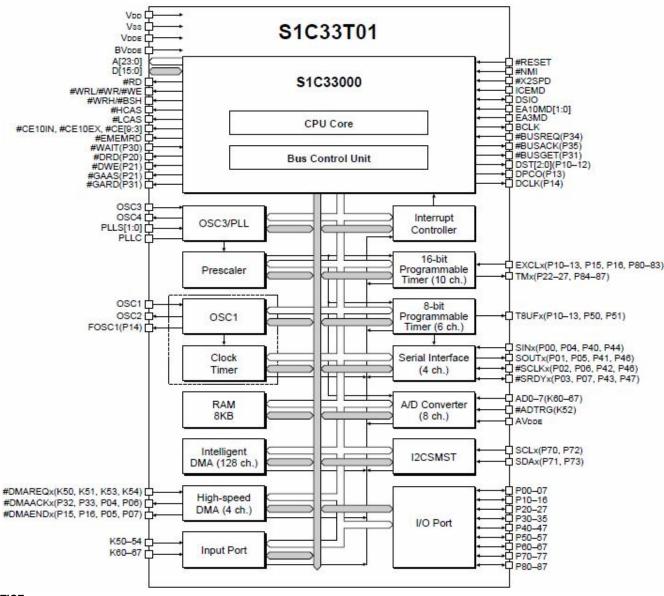
I/O voltage: 1.8 to 5.5V

SLEEP state : $10\mu A$ (3.3V, 32.768kHz, clock timer run state, Typ.) : $2.5\mu A$ (2.0V, 32.768kHz, clock timer run state, Typ.) Current consumption

RUN state: 65mA (3.3V, 50MHz Typ.)

S1C33T01

■ Block Diagram



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